

FDD3860 N-Channel PowerTrench[®] MOSFET 100V, 29A, 36mΩ

Features

- Max $r_{DS(on)} = 36m\Omega$ at $V_{GS} = 10V$, $I_D = 5.9A$
- High performance trench technology for extremely low r_{DS(on)}
- 100% UIL tested
- RoHS Compliant

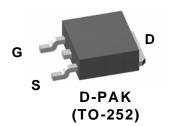


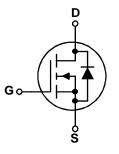
General Description

This N-Channel MOSFET is rugged gate version of Fairchild Semiconductor's advanced Power Trench[®] process. This part is tailored for low $r_{DS(on)}$ and low Qg figure of merit, with avalanche ruggedness for a wide range of switching applications.

Applications

- DC-AC Conversion
- Synchronous Rectifier





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
I _D	Drain Current -Continuous (Silicon limited)	$T_C = 25^{\circ}C$		29		
	-Continuous	$T_A = 25^{\circ}C$	(Note 1a)	6.2	Α	
	-Pulsed			60		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	121	mJ	
P _D	Power Dissipation	$T_{C} = 25^{\circ}C$		69	W	
	Power Dissipation	T _A = 25°C	(Note 1a)	3.1		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

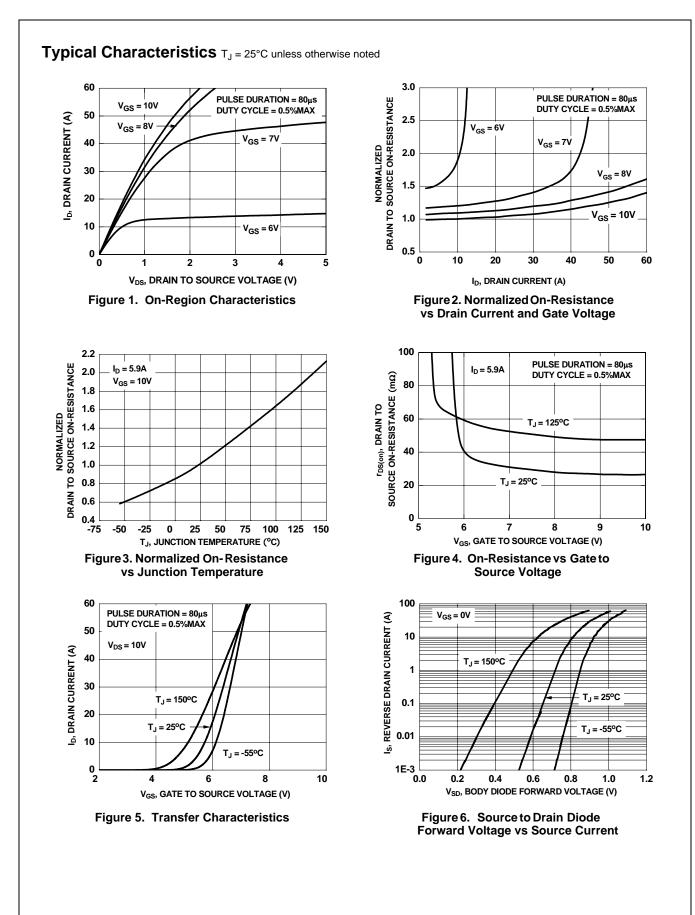
R_{\thetaJC}	Thermal Resistance, Junction to Case	1.8	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	40	C/ VV

Package Marking and Ordering Information

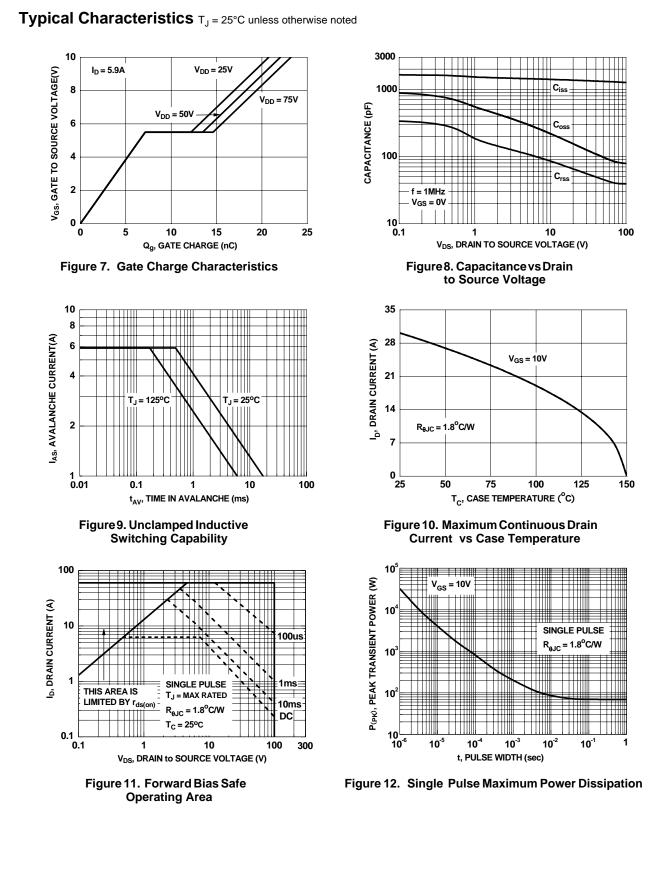
Device Marking	evice Marking Device		Reel Size	Tape Width	Quantity	
FDD3860	FDD3860	D-PAK (TO-252)	13"	12mm	2500 units	

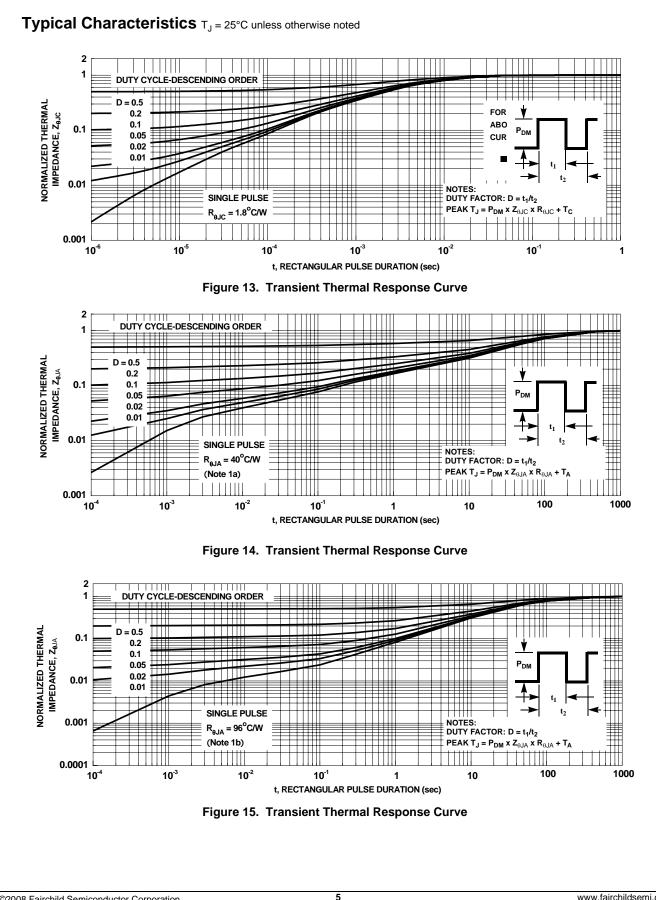
October 2008

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	100			V
∆BV _{DSS}	Breakdown Voltage Temperature Coefficient	$I_{\rm D} = 250 \mu A$, referenced to 25°C		98		mV/°C
ΔT_{J}	Zero Gate Voltage Drain Current	V _{DS} = 80V, V _{GS} = 0V			1	μA
DSS	Gate to Source Leakage Current	$V_{\rm DS} = 600, V_{\rm GS} = 000$ $V_{\rm GS} = \pm 200, V_{\rm DS} = 000$			±100	nA
GSS		VGS - 1200, VDS - 00			100	10.4
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2.5	3.8	4.5	V
$rac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250\mu A$, referenced to $25^{\circ}C$		-11.4		mV/°C
	Static Drain to Source On Resistance	$V_{GS} = 10V, I_D = 5.9A$		29	36	mΩ
DS(on)	Static Drain to Source On Resistance	V_{GS} = 10V, I_{D} = 5.9A, T_{J} = 125°C		51	64	
Ĵfs	Forward Transconductance	V _{DS} = 10V, I _D = 5.9A		20		S
Dvnamic	Characteristics					
C _{iss}	Input Capacitance			1310	1740	pF
C _{oss}	Output Capacitance	$V_{DS} = 50V, V_{GS} = 0V,$		100	130	, pF
C _{rss}	Reverse Transfer Capacitance	f = 1MHz		45	70	pF
R _g	Gate Resistance	f = 1MHz		1.6		Ω
	Characteristics				I	
	Characteristics			10		
d(on)	Turn-On Delay Time	$V_{DD} = 50V, I_D = 5.9A,$ $V_{GS} = 10V, R_{GEN} = 6\Omega$		16	29	ns
r	Rise Time			10	21	ns
d(off)	Turn-Off Delay Time			24	39	ns
f C	Fall Time			7	15	ns
כ ^d	Total Gate Charge at 10V Gate to Source Charge	V _{DD} = 50V, I _D = 5.9A		22 7.1	31	nC nC
ସୁ _{gs} ସୁ _{gd}	Gate to Drain "Miller" Charge			6.3		nC
				0.0		
Drain-Sou	Irce Diode Characteristics					1
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 2.0A$ (Note 2) $V_{GS} = 0V, I_S = 5.9A$ (Note 2)		0.7 0.8	1.2 1.3	V
rr	Reverse Recovery Time			34	55	ns
Q _{rr}	Reverse Recovery Charge	— I _F = 5.9A, di/dt = 100A/μs		40	64	nC
	m of the junction-to-case and case-to-ambient thermal resinteed by design while $R_{\theta JA}$ is determined by the user's box		d as the sole	der mounting	surface of th	ne drain pi
	a) 40°C/W when mo 1 in ² pad of 2 oz		°C/W whe a minimum	n mounted		
	ulse Width < 300µs, Duty cycle < 2.0%. 25°C, L = 3mH, I _{AS} = 9A, V _{DD} = 100V, V _{GS} = 10V.					

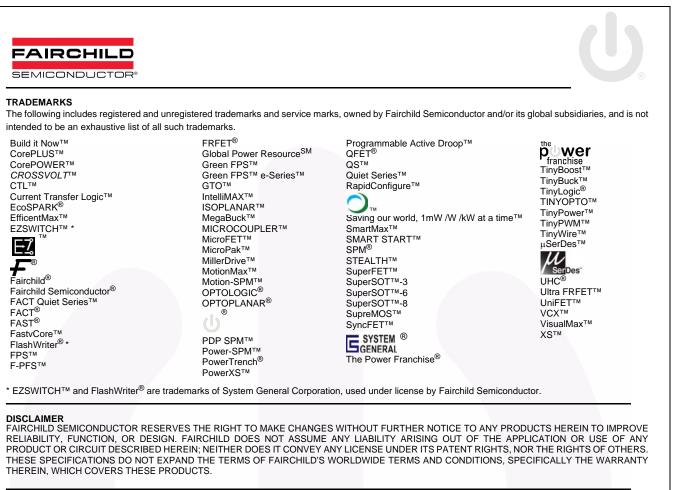








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